

MOSFETs Silicon N-channel MOS (U-MOSVII-H)

TPWR8503NL

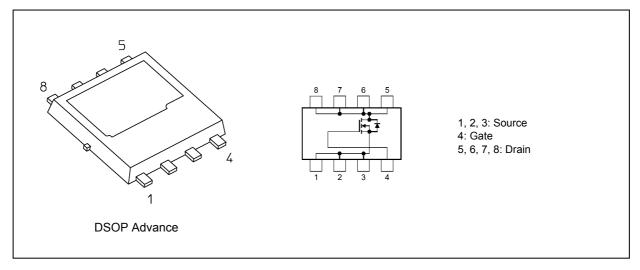
1. Applications

- · High-Efficiency DC-DC Converters
- Switching Voltage Regulators

2. Features

- (1) High-speed switching
- (2) Small gate charge: $Q_{SW} = 16 \text{ nC (typ.)}$
- (3) Low drain-source on-resistance: $R_{DS(ON)} = 1.0 \text{ m}\Omega$ (typ.) ($V_{GS} = 4.5 \text{ V}$)
- (4) Low leakage current: $I_{DSS} = 10 \mu A \text{ (max) (V}_{DS} = 30 \text{ V)}$
- (5) Enhancement mode: $V_{th} = 1.3 \text{ to } 2.3 \text{ V (V}_{DS} = 10 \text{ V}, I_D = 1.0 \text{ mA)}$

3. Packaging and Internal Circuit





4. Absolute Maximum Ratings (Note) (Ta = 25 °C unless otherwise specified)

Characteristi	cs		Symbol	Rating	Unit
Drain-source voltage			V_{DSS}	30	V
Gate-source voltage			V_{GSS}	±20	
Drain current (DC)	(T _c = 25 °C) (Bottom drain)	(Note 1), (Note 2)	I _D	150	Α
Drain current (DC)	(Silicon limit)	(Note 1), (Note 2)	I _D	300	Α
Drain current (pulsed)	(t = 100 μs)	(Note 1)	I _{DP}	500	Α
Power dissipation	(T _c = 25 °C) (Bottom drain)		P_{D}	142	W
Power dissipation		(Note 3)	P _D	2.5	W
Power dissipation		(Note 4)	P _D	0.8	W
Single-pulse avalanche energy		(Note 5)	E _{AS}	318	mJ
Single-pulse avalanche current		(Note 5)	I _{AS}	120	Α
Channel temperature			T _{ch}	150	°C
Storage temperature			T _{stg}	-55 to 150	°C

Note: Using continuously under heavy loads (e.g. the application of high temperature/current/voltage and the significant change in temperature, etc.) may cause this product to decrease in the reliability significantly even if the operating conditions (i.e. operating temperature/current/voltage, etc.) are within the absolute maximum ratings.

Please design the appropriate reliability upon reviewing the Toshiba Semiconductor Reliability Handbook ("Handling Precautions"/"Derating Concept and Methods") and individual reliability data (i.e. reliability test report and estimated failure rate, etc).

5. Thermal Characteristics

Characteristic	Symbol	Max	Unit		
Channel-to-case thermal resistance	Bottom drain (T _c = 25 °C)		R _{th(ch-c)}	0.88	°C/W
Channel-to-case thermal resistance	Top source (T _c = 25 °C)		R _{th(ch-c)}	0.93	°C/W
Channel-to-ambient thermal resistance	(T _a = 25 °C)	(Note 3)	R _{th(ch-a)}	50	°C/W
Channel-to-ambient thermal resistance	(T _a = 25 °C)	(Note 4)	R _{th(ch-a)}	156	°C/W

Note 1: Ensure that the channel temperature does not exceed 150 °C.

Note 2: Limited by package limit. Silicon chip capability is 300 A. (T_c = 25 °C)

Note 3: Device mounted on a glass-epoxy board (a), Figure 5.1

Note 4: Device mounted on a glass-epoxy board (b), Figure 5.2

Note 5: V_{DD} = 24 V, T_{ch} = 25 °C (initial), L = 17 μH , I_{AS} = 120 A

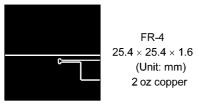
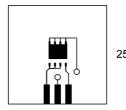


Fig. 5.1 Device Mounted on a Glass-Epoxy
Board (a)



FR-4 $25.4 \times 25.4 \times 1.6$ (Unit: mm) 2 oz copper

Fig. 5.2 Device Mounted on a Glass-Epoxy Board (b)

Note: This transistor is sensitive to electrostatic discharge and should be handled with care.



6. Electrical Characteristics

6.1. Static Characteristics ($T_a = 25$ °C unless otherwise specified)

Characteristics	Symbol	Test Condition	Min	Тур.	Max	Unit
Gate leakage current	I _{GSS}	$V_{GS} = \pm 20 \text{ V}, V_{DS} = 0 \text{ V}$	_	_	±0.1	μА
Drain cut-off current	I _{DSS}	V _{DS} = 30 V, V _{GS} = 0 V			10	
Drain-source breakdown voltage	V _{(BR)DSS}	I _D = 10 mA, V _{GS} = 0 V	30			V
	V _{(BR)DSX}	$I_D = 10 \text{ mA}, V_{GS} = -20 \text{ V}$	15	_	_	
Gate threshold voltage	V_{th}	V _{DS} = 10 V, I _D = 1.0 mA	1.3		2.3	
Drain-source on-resistance	R _{DS(ON)}	$V_{GS} = 4.5 \text{ V}, I_D = 50 \text{ A}$		1.0	1.3	mΩ
		V _{GS} = 10 V, I _D = 50 A	_	0.72	0.85	

6.2. Dynamic Characteristics (T_a = 25 °C unless otherwise specified)

Characteristics	Symbol	Test Condition	Min	Тур.	Max	Unit
Input capacitance	C _{iss}	V _{DS} = 15 V, V _{GS} = 0 V, f = 1 MHz	_	5300	6900	pF
Reverse transfer capacitance	C_{rss}		_	130	_	
Output capacitance	C _{oss}		_	2700	_	
Gate resistance	r _g	_	_	1.2	1.8	Ω
Switching time (rise time)	t _r	See Fig. 6.2.1	_	9.6	_	ns
Switching time (turn-on time)	t _{on}		_	23	_	
Switching time (fall time)	t _f		_	15	_	
Switching time (turn-off time)	t _{off}		_	89	_	

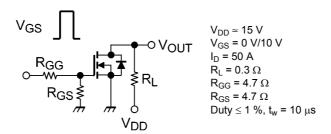


Fig. 6.2.1 Switching Time Test Circuit

6.3. Gate Charge Characteristics (T_a = 25 °C unless otherwise specified)

Characteristics	Symbol	Test Condition	Min	Тур.	Max	Unit
Total gate charge (gate-source plus	Q_g	$V_{DD} \approx 15 \text{ V}, V_{GS} = 10 \text{ V}, I_D = 50 \text{ A}$	_	74		nC
gate-drain)		$V_{DD} \approx 15 \text{ V}, V_{GS} = 4.5 \text{ V}, I_D = 50 \text{ A}$		32		
Gate-source charge 1	Q _{gs1}	$V_{DD} \approx 15 \text{ V}, V_{GS} = 10 \text{ V}, I_D = 50 \text{ A}$	_	19		
Gate-drain charge	Q_{gd}		_	6.5	_	
Gate switch charge	Q_SW		_	16		

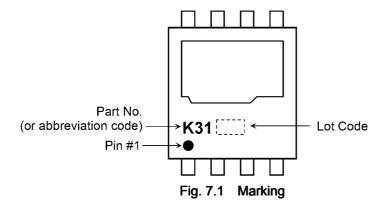
6.4. Source-Drain Characteristics (T_a = 25 °C unless otherwise specified)

Characteristics	Symbol	Test Condition	Min	Тур.	Max	Unit
Reverse drain current (pulsed) (Note 6)	I _{DRP} (t = 100 μs)	_	_	_	500	Α
Diode forward voltage	V _{DSF}	I _{DR} = 150 A, V _{GS} = 0 V	_	_	-1.2	V
Reverse recovery time		V _R = 15 V, I _{DR} = 37.5 A, V _{GS} =	-	58	_	ns
Reverse recovery charge	Q _{rr}	0 V, -dl _{DR} /dt = 100 A/μs	_	71	_	nC

Note 6: Ensure that the channel temperature does not exceed 150 °C.



7. Marking





8. Characteristics Curves (Note)

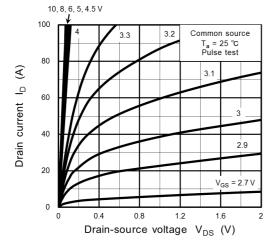
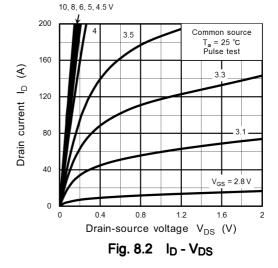


Fig. 8.1 I_D - V_{DS}



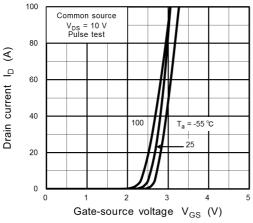


Fig. 8.3 I_D - V_{GS}

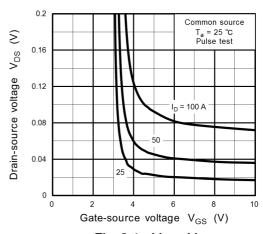


Fig. 8.4 V_{DS} - V_{GS}

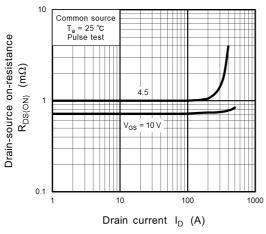


Fig. 8.5 R_{DS(ON)} - I_D

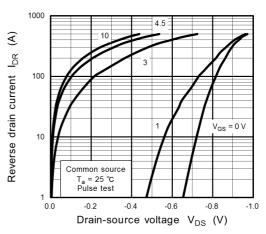


Fig. 8.6 I_{DR} - V_{DS}



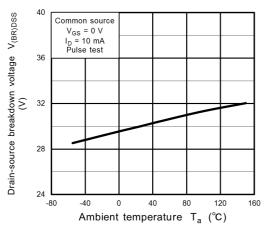


Fig. 8.7 V_{(BR)DSS} - T_a

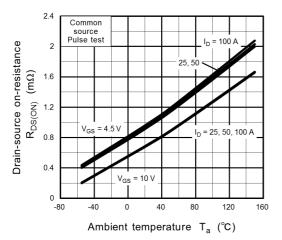


Fig. 8.9 R_{DS(ON)} - T_a

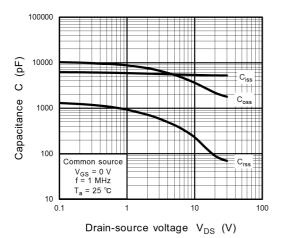


Fig. 8.11 Capacitance - V_{DS}

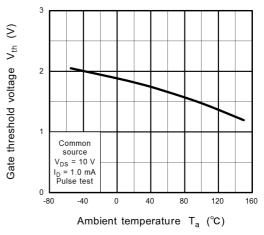


Fig. 8.8 V_{th} - T_a

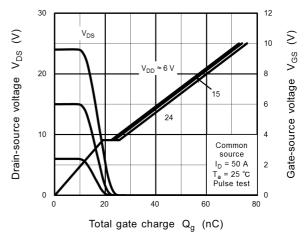


Fig. 8.10 Dynamic Input/Output Characteristics



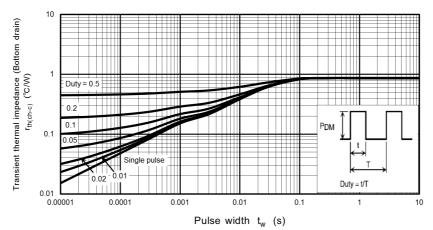


Fig. 8.12 r_{th} - t_w (Bottom drain) (Guaranteed Maximum)

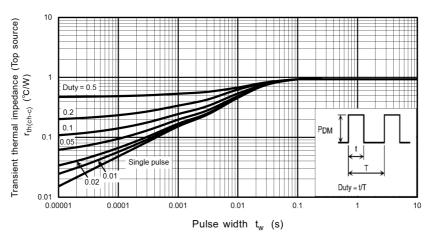


Fig. 8.13 r_{th} - t_w (Top source) (Guaranteed Maximum)

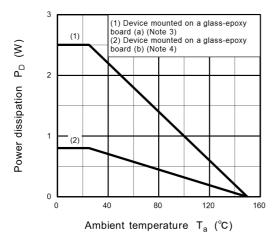


Fig. 8.14 P_D - T_a (Guaranteed Maximum)

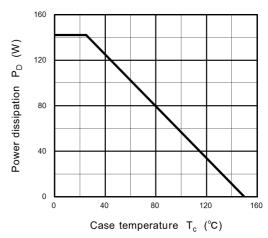


Fig. 8.15 P_D - T_c (Bottom drain) (Guaranteed Maximum)

Rev.4.0



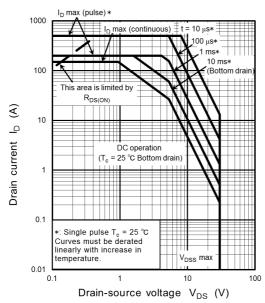


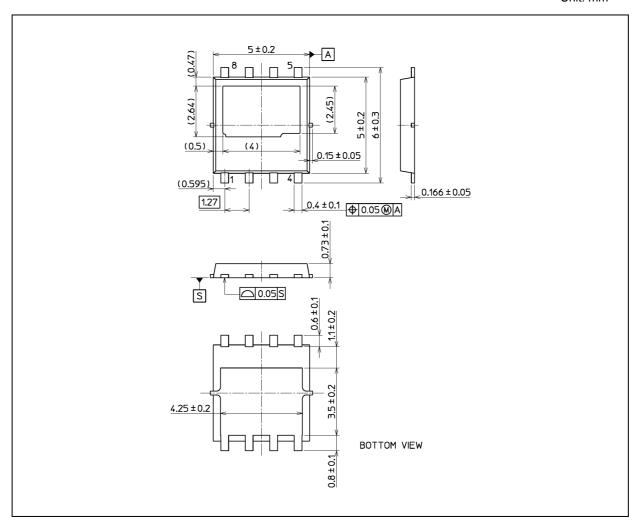
Fig. 8.16 Safe Operating Area (Guaranteed Maximum)

Note: The above characteristics curves are presented for reference only and not guaranteed by production test, unless otherwise noted.



Package Dimensions

Unit: mm



Weight: 0.104 g (typ.)

Package Name(s)
TOSHIBA: 2-5S1A
Nickname: DSOP Advance



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